



INTRODUCTION

YY-5750, YY-5850 & YY-5950, Pitch:3.0mm series is high-density, low-power connector system available in wire-to-wire and wire-to-board configurations with SMT and through-hole options and up to 5.0A to meet low-to mid-range power application needs.

- Latch assures connectors are fully mated.
- Positive locking prevents accidental unmating.
- Receptacles, panel mount or free-hanging plugs, and headers.
- Headers are available in through-hole, SMT, vertical and right-angle configurations, with solder tab or snap-in plastic Peg PCB lock.

Connector Systems Table of Contents 3.00mm (.118") Pitch / Wire To Board Connectors



SPECIFICATION

- Rated current : 5A Max.
- Rated voltage : 250 V AC ,DC
- Contact resistance : 10 mΩ Max.
- Insulation resistance : 1,000 MΩ Min.
- Dielectric withstand voltage : 1500V AC / minute
- Temperature range : -25 °C / +85 °C
- Packaging : Header - Bag
Housing - Bag
Terminals - Reel

CONSUMER

- Automotive Vehicles
- Consumer Products
- Data/Communication systems
- Industrial Applications
- Medical Applications
- Networking